

Ceramic, AUTO-FlexTerm-(CxxxxX-AUTO), 330 pF, 5%, 250 V, 0603, C0G, SMD, MLCC, FT-CAP, Ultra-Stable, Automotive Grade



| Dimensions | |
|------------|------------------|
| L | 1.6mm +/-0.17mm |
| W | 0.8mm +/-0.15mm |
| T | 0.8mm +/-0.15mm |
| S | 0.58mm MIN |
| B | 0.45mm +/-0.15mm |

| Packaging Specifications | |
|--------------------------|------------------------|
| Packaging: | T&R, 180mm, Paper Tape |
| Packaging Quantity: | 4000 |

| General Information | |
|---------------------|---|
| Style: | SMD Chip |
| Series: | AUTO-FlexTerm-(CxxxxX-AUTO) |
| Chip Size: | 0603 |
| Description: | SMD, MLCC, FT-CAP, Ultra-Stable, Automotive Grade |
| Features: | FT-CAP, Ultra-Stable, Automotive Grade |
| RoHS: | Yes |
| Termination: | Flexible Termination |
| Marking: | No |
| Failure Rate: | N/A |
| Approvals: | AEC-Q200 |
| AEC-Q200: | Yes |

| Specifications | |
|----------------------------------|---------------------|
| Capacitance: | 330 pF |
| Capacitance Tolerance: | 5% |
| Voltage DC: | 250 VDC |
| Dielectric Withstanding Voltage: | 625 V |
| Temperature Range: | -55/+125C |
| Temperature Coefficient: | C0G |
| Dissipation Factor: | 0.1% |
| Aging Rate: | 0% Loss/Decade Hour |
| Insulation Resistance: | 100 GOhms |